



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Applicants: Donald C. Foster and Kelly R. McKendrick, Sr.  
Assignee: Amkor Technology, Inc.  
Title: Leadframe Having Fine Pitch Bond Fingers Formed Using Laser Cutting Method  
Serial No.: 09/895,501 Filing Date: June 29, 2001  
Docket No.: M-11315 US

San Jose, California  
October 8, 2001

COMMISSIONER FOR PATENTS  
Washington, D.C. 20231

**INFORMATION DISCLOSURE STATEMENT  
UNDER 37 CFR § 1.97(b)**

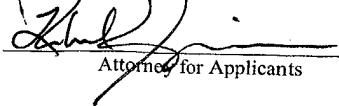
Dear Sir:

Pursuant to 37 C.F.R. § 1.56, § 1.97 and § 1.98, the documents listed on the accompanying form PTO-1449 are called to the attention of the Examiner for the above patent application. Copies of these documents are enclosed.

Citation of these documents shall not be construed as:

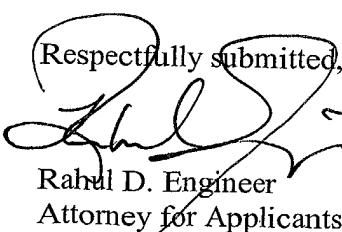
1. an admission that the documents are necessarily prior art with respect to the instant invention;
2. a representation that a search has been made, other than as described above; or
3. an admission that the information cited herein is, or is considered to be, material to patentability as defined in § 1.56(b).

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on October 8, 2001.

  
Attn: for Applicants

10-8-01  
Date of Signature

Respectfully submitted,

  
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H2 P.D. 10-3836

U.S. Department of Commerce, Patent and Trademark Office		Atty Docket No.	Serial No.
		M-11315 US	09/895,501
INFORMATION DISCLOSURE STATEMENT BY APPLICANT		Applicants: Donald Craig Foster and	
(Use several sheets if necessary)		Kelly Robbins McKendrick, Sr.	
		Filing Date: 6/29/01	Group

## U.S. Patent Documents

*Examiner Initial	Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
AA	5,521,429	05/28/96	Aono et al.	257	676	
AB	5,977,630	11/02/99	Woodworth et al.	257	712	
AC	6,025,640	02/15/00	Yagi et al.	257	666	
AD	6,130,115	10/10/00	Okumura et al.	438	124	
AE	6,143,981	11/07/00	Glenn	174	52.4	
AF	6,198,171 B1	03/06/01	Huang et al.	257	787	
AH	6,225,146 B1	05/01/01	Yamaguchi et al.	438	123	
AG	6,229,200 B1	05/08/01	Mclellan et al.	257	666	
AI	6,242,281 B1	06/05/01	Mclellan et al.	438	106	
AJ	6,281,568 B1	08/28/01	Glenn et al.	257	684	

## Foreign Patent Documents

							Translation	
		Document	Date	Country	Class	Subclass	Yes	No
	AK	59-227143	12/20/84	Japan			X	
	AL	60-195957	10/04/85	Japan			X	
	AM	DE19734794A1	07/16/98	Germany				X
	AN	EP0794572A2	10/09/97	Europe			X	
	AO	7-312405	11/28/95	Japan			X	
	AP	8-125066	05/17/96	Japan			X	
	AQ	8-306853	11/22/96	Japan			X	
	AR	9-8205	01/10/97	Japan			X	
	AS	9-8206	01/10/97	Japan			X	
	AT	9-8207	01/10/97	Japan			X	
	AU	9-92775	04/04/97	Japan			X	

## OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

AV	
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+Examiner Date Considered

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant.